

Supply of technology

**EDER Engineering GmbH/Ltd.**  
precision die-tools  
for the international wire-/cable industry

and equipments

**WIRE 2008 Duesseldorf ( 12 to 16 April, 2010)**  
**Eder-Engineering-Austria Participation: Stand No. 10A40-01+02**

**Eder-Stand** located at our traditional position in **Hall 10**. (Austrian Pavillion)

**Stand Personnel :** Dr. K. Eder, Mrs. I. Eder, Ms. A. Eder, Mr. B. Eder, Mr. C. Strobl,  
W. Eberhardt, + members of Eder's intl. representations.

Eder Engineering-Austria and with a leadership and experience for over 60 years in ultrahard precision die-tools and particularly in advanced die-tool processing machines, will display the following exhibits/developments at their large Stand in **Hall 10**

**1) For processing of diamond/PCD wire drawing dies / Die Workshop Equipment:**

**USP-Twin** - revolutionary Ultrasonic machine with two workstations to be operated by one only operator while offering double efficiency !

**HGM-21** - Twin spindle high speed wire-type sizing/calibrating machine with two independent workstations and extended workrange.

**UFW-1** - Fine Wire-type sizing/polishing machine for ultrafine die-bores

**2) A range of advanced semi- and fully automatic machines for processing of tungsten carbide dies with round bores**

**ETC-1/HF** Semi-automatic tc die grinding+polishing machine for cone+bearing.

**TCLD-CB-CNC** Automatic CNC controlled machine for processing of round tc wire drawing dies ranging between 1.0 to 6.0 mm Ø

**3) Ancillary equipment to complement each die-workshop:**

**DIM Zoom 160** - Stereoscopic Binocular Zoom Die Inspectioning Microscope

**DEZ 2/080** - Motorized measuring wire pulling device.

**ZTE** - Wire pulling and elongation measuring device.

**VDSU** - Vacuum drawing die suction unit.

- Measuring Pins, Workpins, Micrometers etc.

**4) Precision Wire Drawing Die-Tools: Tungsten Carbide, Natural Diamond, PCD**

**5) EID/DIAPOL: Diamond Powders, -Pastes –Suspensions etc.**